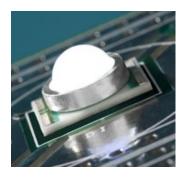
Cree® XLamp® XR-C LEDs



PRODUCT DESCRIPTION

The XLamp[®] XR-C LED gives lighting designers the flexibility and performance to create the next generation of LED lighting products. XLamp XR-C LEDs feature electrically neutral thermal path, low thermal resistance and support for a wide range of drive currents.

Cree XLamp LEDs bring high performance and quality of light to a wide range of lighting applications, including color-changing, portable and personal, outdoor, indoor-directional, transportation, stage and studio, commercial and emergency-vehicle lighting.

FEATURES

- Available in white (2600 K to 10,000 K CCT), royal blue, blue, green, amber, red-orange & red
- Maximum drive current: up to 700 mA
- Low thermal resistance: as low as 12 °C/W
- Maximum junction temperature: 150 °C
- Industry-leading JEDEC standard pre-qualification testing
- Reflow solderable JEDEC J-STD-020C compatible
- Electrically neutral thermal path
- Lumen maintenance of greater than
 70% after 50,000 hours
- RoHS and REACh compliant
- UL[®] recognized component (E349212)



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CHARACTERISTICS - WHITE, ROYAL BLUE, BLUE, GREEN

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point	°C/W		12	
Viewing angle (FWHM) - white	degrees		90	
Viewing angle (FWHM) - royal blue, blue, green	degrees		100	
Temperature coefficient of voltage	mV/°C		-4.0	
ESD classification (HBM per Mil-Std-883D)			Class 2	
DC forward current	mA			500
Reverse voltage	V			5
Forward voltage (@ 350 mA) - white, royal blue, blue	V		3.5	4.0
Forward voltage (@ 350 mA) - green	V		3.7	4.0
Forward voltage (@ 500 mA) - white, royal blue, blue	V		3.6	
LED junction temperature*	°C			150

* Note: For lumen maintenance data, see the Cree XLamp LED Reliability document.

CHARACTERISTICS - AMBER, RED-ORANGE, RED

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point	°C/W		15	
Viewing angle (FWHM)	degrees		90	
Temperature coefficient of voltage - red-orange, red	mV/°C		-2.3	
Temperature coefficient of voltage - amber	mV/°C		-1.8	
ESD classification (HBM per Mil-Std-883D)			Class 2	
DC forward current - red-orange, red	mA			700
DC forward current - amber	mA			350
Reverse voltage	V			5
Forward voltage (@ 350 mA)	V		2.2	2.5
Forward voltage (@ 700 mA) - red-orange, red	V		2.4	
LED junction temperature*	°C			150

* Note: For lumen maintenance data, see the Cree XLamp LED Reliability document.

FLUX CHARACTERISTICS - WHITE (T_j = 25 °C)

The following tables describe the available colors and flux for XR-C LEDs by listing the correlated color temperature range for the entire family and by providing several base order codes. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XR LED Family Binning and Labeling document.

Color	CCT F	Range		minous Flux n)	Order Code
	Minimum	Maximum	Group	Flux (lm)	
			N3	56.8	XRCWHT-L1-0000-00501
			N4	62.0	XRCWHT-L1-0000-00601
Cool White	E 000 K	10.000 //	P2	67.2	XRCWHT-L1-0000-00701
Cool white	5,000 K	10,000 K	P3	73.9	XRCWHT-L1-0000-00801
			P4	80.6	XRCWHT-L1-0000-00901
			Q2	87.4	XRCWHT-L1-0000-00A01
			N3	56.8	XRCWHT-L1-0000-005E4
			N4	62.0	XRCWHT-L1-0000-006E4
Neutral White	3,700 K	5,000 K	P2	67.2	XRCWHT-L1-0000-007E4
			P3	73.9	XRCWHT-L1-0000-008E4
			P4	80.6	XRCWHT-L1-0000-009E4
			M3	45.7	XRCWHT-L1-0000-003E7
			N2	51.7	XRCWHT-L1-0000-004E7
Warm White	2,600 K	3,700 K	N3	56.8	XRCWHT-L1-0000-005E7
			N4	62.0	XRCWHT-L1-0000-006E7
			P2	67.2	XRCWHT-L1-0000-007E7

Notes:

- Cree maintains a tolerance of ±7% on flux and power measurements, ±0.005 on chromaticity (CCx, CCy) measurements and ±2 on CRI measurements. See the Measurements section (page 12).
- Typical CRI for Cool White & Neutral White (3,700 K 10,000 K CCT) is 75.
- Typical CRI for Warm White (2,600 K 3,700 K CCT) is 80.

FLUX CHARACTERISTICS - COLOR (T_j = 25 °C)

	Do	minant Wav	elength Rar	nge	Minimum Radiant			
Color	Minimum		Maximum		Flux (mW)		Order Code	
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (mW)		
Royal	52	450 05	450	DE	46 F	12	250	XRCROY-L1-0000-00701
Blue	D3	450	D5 465	405	13	300	XRCROY-L1-0000-00801	



FLUX CHARACTERISTICS - COLOR (T_J = 25 °C) - CONTINUED

	Do	minant Wav	elength Rar	ige	Minimun	n Luminous			
Color	Minimum		Maxi	mum	Flux (lm)		Flux (lm)		Order Code
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)			
Dhue	B3	465	D4	475	G	13.9	XRCBLU-L1-0000-00G01		
Blue	B3	465	B4	B4 475	н	18.1	XRCBLU-L1-0000-00H01		

	Do	minant Wav	elength Rar	ıge	Minimum Luminous			
Color	Minimum		Maximum		Flux (lm)		Order Code	
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)		
Green	G2	520	64	525	М	39.8	XRCGRN-L1-0000-00M01	
Green	62	520	64	G4 535		51.7	XRCGRN-L1-0000-00N01	

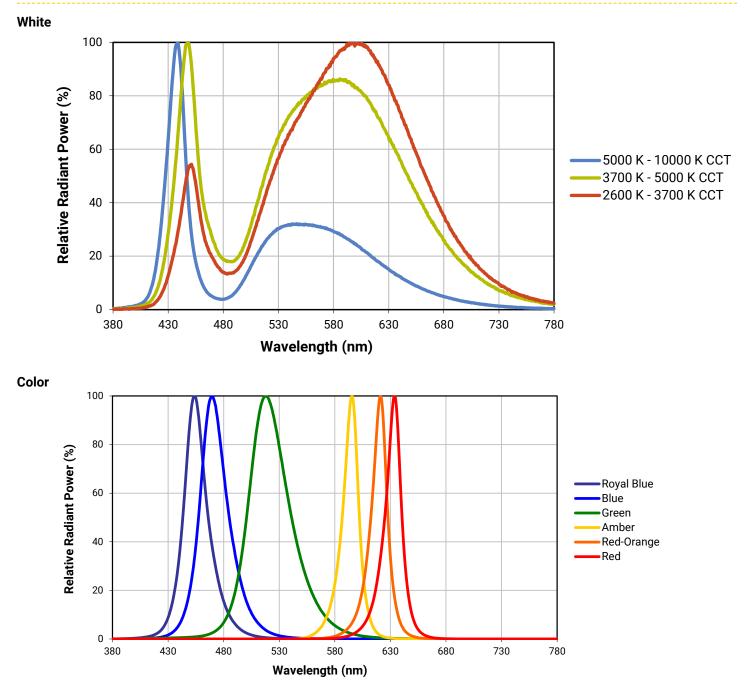
	Do	minant Wav	elength Rar	ige	Minimum Luminous						
Color	Minimum		Maxi	mum	Flux (lm)		Flux (lm)		Order Code		
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)					
			A3	A3					J	23.5	XRCAMB-L1-0000-00J01
Amber	A2	585			3 595	K2	30.6	XRCAMB-L1-0000-00K01			
					M2	39.8	XRCAMB-L1-0000-00M01				

	Do	minant Wav	elength Rar	nge	Minimum	n Luminous				
Color	Mini	mum	Maxi	mum	Flux (lm)		Flux (lm)		Order Code	
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)				
Red-	02	610 04	03 610 04 620	04	04	610 04	620	K2	30.6	XRCRDO-L1-0000-00K01
Orange	03 610 04	04	04 620	M2	39.8	XRCRDO-L1-0000-00M01				

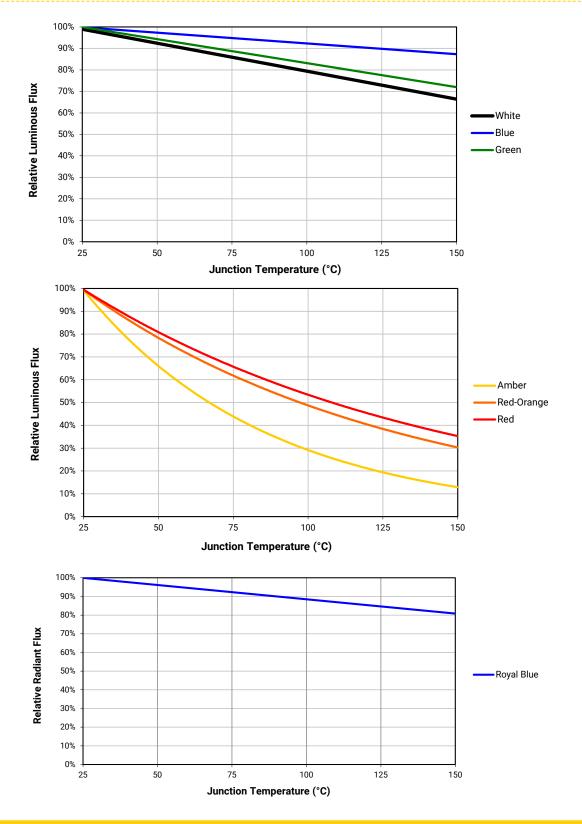
	Doi	minant Wav	elength Rar	ıge	Minimum	Luminous				
Color	Minii	mum	Maxi	mum	Flux (lm)		Order Code			
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)				
									J 23.5 X	XRCRED-L1-0000-00J01
Red	R2	620	R3	630	K2	30.6	XRCRED-L1-0000-00K01			
					M2	39.8	XRCRED-L1-0000-00M01			

Note: Cree maintains a tolerance of $\pm 7\%$ on flux and power measurements, ± 0.005 on chromaticity (CCx, CCy) measurements, ± 2 on CRI measurements and ± 1 nm on dominant wavelength measurements. See the Measurements section (page 12).

RELATIVE SPECTRAL POWER DISTRIBUTION

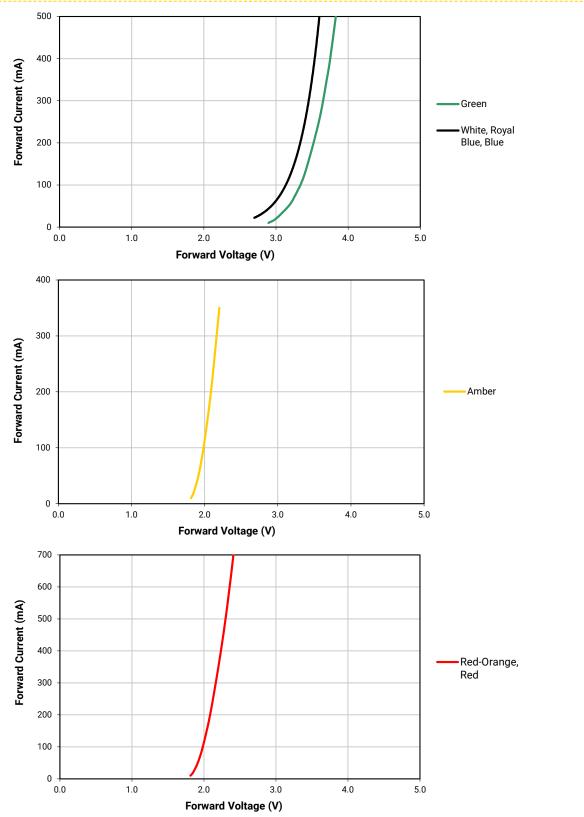


RELATIVE FLUX VS. JUNCTION TEMPERATURE (I_F = 350 mA)



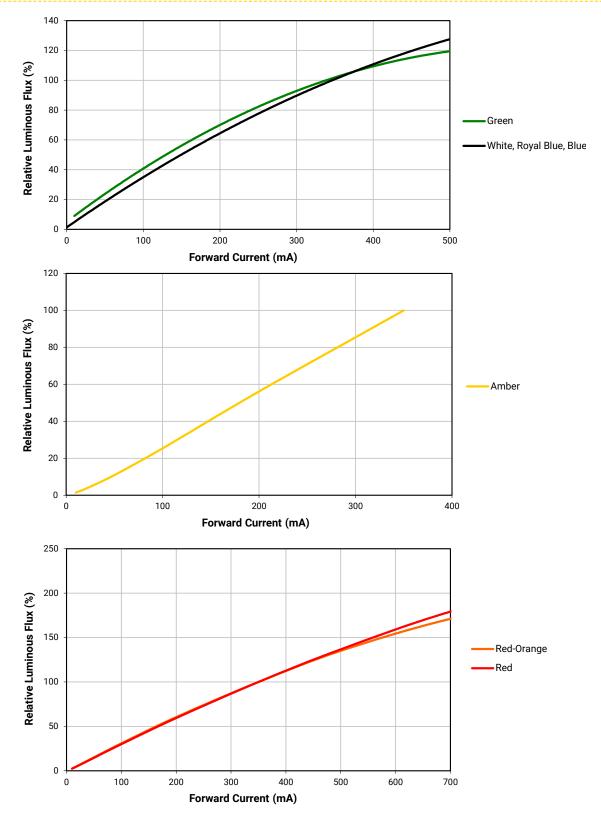
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ELECTRICAL CHARACTERISTICS (T_J = 25 °C)



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RELATIVE FLUX VS. CURRENT (T_j = 25 °C)

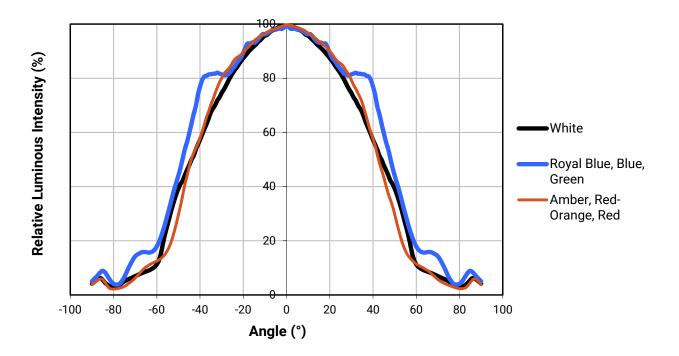


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XLAMP[®] XR-C LED

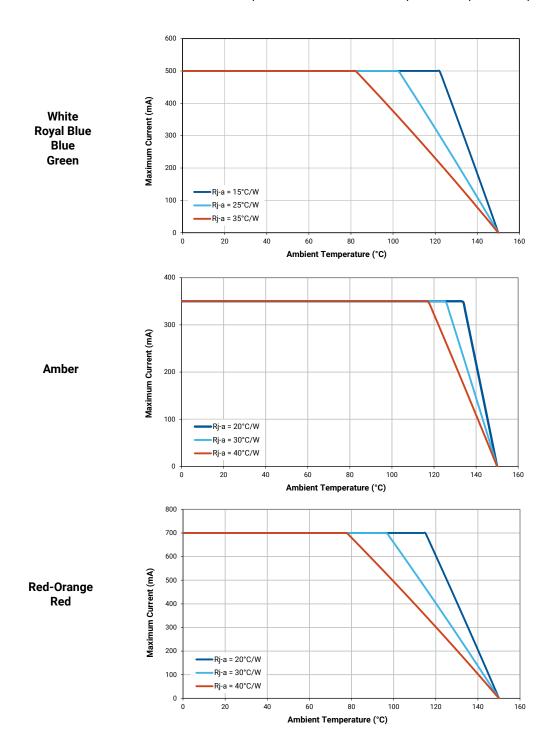


TYPICAL SPATIAL DISTRIBUTION



THERMAL DESIGN

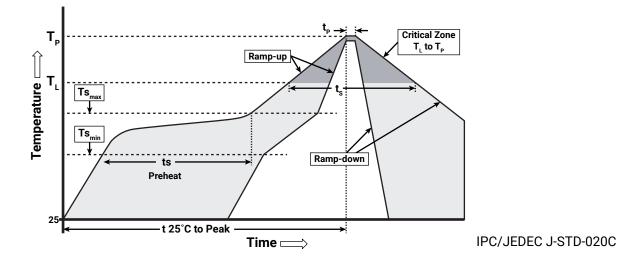
The maximum forward current is determined by the thermal resistance between the LED junction and ambient. Given an existing thermal resistance of 12 °C/W or 15 °C/W between the junction and the solder point, it is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.



REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp XR-C LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of the solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



Profile Feature	Lead-Free Solder
Average Ramp-Up Rate (Ts _{max} to Tp)	1.2 °C/second
Preheat: Temperature Min (Ts _{min})	120 °C
Preheat: Temperature Max (Ts _{max})	170 °C
Preheat: Time (ts _{min} to ts _{max})	65-150 seconds
Time Maintained Above: Temperature (T_L)	217 °C
Time Maintained Above: Time (t_{L})	45-90 seconds
Peak/Classification Temperature (Tp)	235 - 245 °C
Time Within 5 °C of Actual Peak Temperature (tp)	20-40 seconds
Ramp-Down Rate	1 - 6 °C/second
Time 25 °C to Peak Temperature	4 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.

NOTES

Measurements

The luminous flux, radiant power, chromaticity, forward voltage and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended as specifications.

Pre-Release Qualification Testing

Please read the LED Reliability Overview for details of the qualification process Cree applies to ensure long-term reliability for XLamp LEDs and details of Cree's pre-release qualification testing for XLamp LEDs.

Lumen Maintenance

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document.

Please read the Long-Term Lumen Maintenance application note for more details on Cree's lumen maintenance testing and forecasting. Please read the Thermal Management application note for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

Moisture Sensitivity

Cree recommends keeping XLamp XR-C LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain XLamp LEDs do not need special storage for moisture sensitivity.

Once the MBP is opened, XLamp XR-C LEDs should be handled and stored as MSL 4 per JEDEC J-STD-033, meaning they have limited exposure time before damage to the LED may occur during the soldering operation. The table on the right specifies the maximum exposure time in days depending on temperature and humidity conditions. LEDs with

T	Maximum Percent Relative Humidity										
Temp.	30%	40%	50%	60%	70%	80%	90%				
30 °C	9	5	4	3	1	1	1				
25 °C	12	7	5	4	2	1	1				
20 °C	17	9	7	6	2	2	1				

exposure time longer than the specified maximums must be baked according to the baking conditions listed below.

Baking Conditions

It is not necessary to bake all XLamp LEDs. Only the LEDs that meet all of the following criteria must be baked:

- LEDs that have been removed from the original MBP.
- LEDs that have been exposed to a humid environment longer than listed in the Moisture Sensitivity section above.
- LEDs that have not been soldered.

LEDs should be baked at 80 °C for 24 hours. LEDs may be baked on the original reels. Remove LEDs from the MBP before baking. Do not bake parts at temperatures higher than 80 °C. This baking operation resets the exposure time as defined in the Moisture Sensitivity section above.

NOTES - CONTINUED

Storage Conditions

XLamp LEDs that have been removed from the original MBP but not soldered yet should be stored in a room or cabinet that will maintain an atmosphere of 25 ± 5 °C and no greater than 10% RH (relative humidity). For LEDs stored in these conditions, storage time does not add to exposure time as defined in the Moisture Sensitivity section above.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree representative or from the Product Documentation sections of www.cree.com.

REACh Compliance

REACh substances of very high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

UL® Recognized Component

Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/ UL 8750.

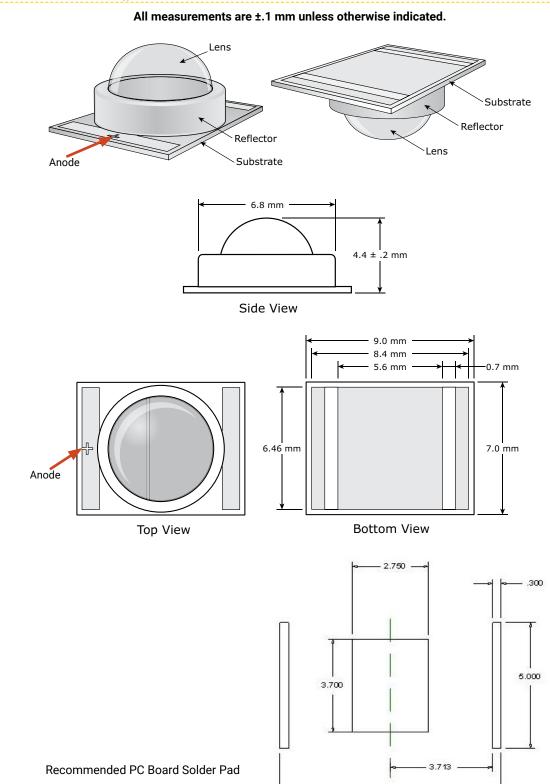
Vision Advisory

WARNING: Do not look at an exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the LED Eye Safety application note.

Intellectual Property

For remote phosphor applications, a separate license to certain Cree patents is required.

MECHANICAL DIMENSIONS ($T_A = 25 \degree C$)



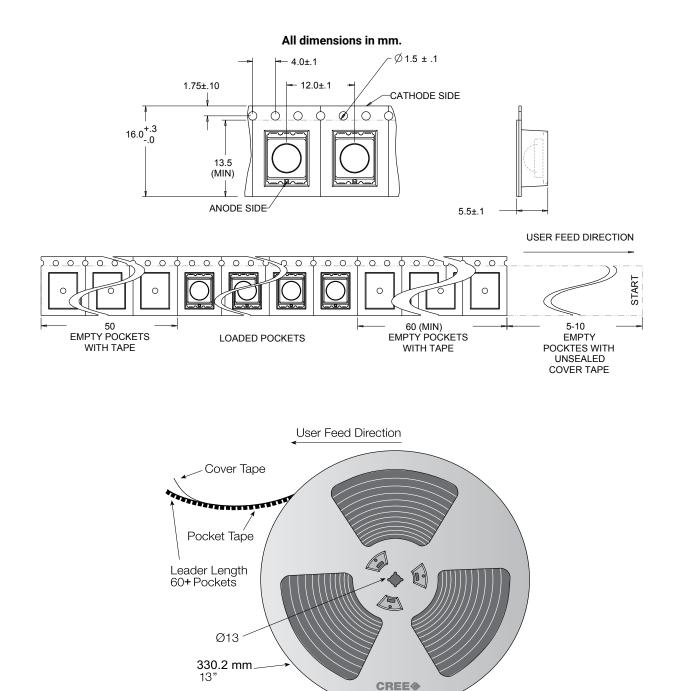
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TAPE AND REEL

All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.





PACKAGING

